

July 2016

FCB070N65S3

N-Channel SuperFET® III MOSFET

650 V, 44 A, 70 mΩ

Features

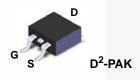
- $700 \text{ V } @ \text{ T}_{\text{J}} = 150 \, {}^{\text{O}}\text{C}$
- $R_{DS(on)} = 62 \text{ m}\Omega \text{ (Typ.)}$
- Ultra Low Gate Charge (Typ. Q_g = 78 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 715 pF)
- 100% Avalanche Tested
- RoHS Compliant

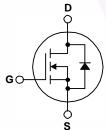
Applications

- Telecom / Server Power Supplies
- · Industrial Power Supplies
- UPS / Solar

Description

SuperFET[®] III MOSFET is Fairchild Semiconductor's brandnew high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advance technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate. Consequently, SuperFET III MOSFET is very suitable for various AC/DC power conversion for system miniaturization and higher efficiency.





Absolute Maximum Ratings $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol		Parameter			
V _{DSS}	Drain to Source Voltage			650	V
	Cata ta Cauraa Valtaria	- DC		±30	.,
V _{GSS} Gate to	Gate to Source Voltage	- AC (f>	1 Hz)	±30	V
Desire Occurrent		- Continuous (T _C = 25°C)		44	^
Drain Current	- Continuous (T _C = 100°C)		28	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	110	Α
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			1160	mJ
I _{AR}	Avalanche Current (Note 1)		8.8	Α	
E _{AR}	Repetitive Avalanche Energy	Repetitive Avalanche Energy (Note 1)			mJ
	MOSFET dv/dt			100	1//
dv/dt	Peak Diode Recovery dv/dt	((Note 3)	20	V/ns
D	Davies Dissination	$(T_C = 25^{\circ}C)$		312	W
P_{D}	Power Dissipation	- Derate Above 25°C		2.5	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°С
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C

Thermal Characteristics

Symbol	Parameter	FCB070N65S3	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.4	
D	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	62.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (1 in ² Pad of 2-oz Copper), Max.	40	

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FCB070N65S3	FCB070N65S3	D ² -PAK	Tape and Reel	330 mm	24 mm	800 units

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	lest Conditions	win.	Typ.	wax.	Unit
Off Chara	cteristics					
BV _{DSS} Drain to Source Breakdown Vol	Drain to Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}, T_J = 25^{\circ}\text{C}$	650	-	-	V
	Diam to Source Breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}, T_J = 150^{\circ}\text{C}$	700	-	-	V
ΔBV_{DSS} / ΔT_J	Breakdown Voltage Temperature Coefficient	I _D = 1 mA, Referenced to 25°C	-	0.72	-	V/°C
1	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μА
IDSS	Zero Gate voltage Drain Current	$V_{DS} = 520 \text{ V}, V_{GS} = 0 \text{ V}, T_{C} = 125^{\circ}\text{C}$	-	2.2	-	μΑ
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$	_	-	±100	nA

On Characteristics

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 4.4$ mA	2.5	-	4.5	V
R _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, I_D = 22 \text{ A}$	•	62	70	mΩ
9 _{FS}	Forward Transconductance	$V_{DS} = 20 \text{ V}, I_{D} = 22 \text{ A}$	-	29	-	S

Dynamic Characteristics

C _{iss}	Input Capacitance	$V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V},$	- \	3090	-	pF
C _{oss}	Output Capacitance	f = 1 MHz	-	68	-	pF
C _{oss(eff.)}	Effective Output Capacitance	$V_{DS} = 0 \text{ V to } 400 \text{ V}, V_{GS} = 0 \text{ V}$		715	-	pF
C _{oss(er.)}	Energy Related Output Capacitance	$V_{DS} = 0 \text{ V to } 400 \text{ V}, V_{GS} = 0 \text{ V}$	-	104	-	pF
Q _{g(tot)}	Total Gate Charge at 10V	V _{DS} = 400 V, I _D = 22 A,	-	78	-	nC
Q_{gs}	Gate to Source Gate Charge	V _{GS} = 10 V	-	18	-	nC
Q_{gd}	Gate to Drain "Miller" Charge	(Note 4)	-	30	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	0.6	-	Ω

Switching Characteristics

t _{d(on)}	Turn-On Delay Time		-	26	-	ns
t _r		$V_{DD} = 400 \text{ V}, I_D = 22 \text{ A},$	-	52	-	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, R_g = 4.7 \Omega$	- /	89	-	ns
t _f	Turn-Off Fall Time	(Note 4)	-	16	-	ns

Drain-Source Diode Characteristics

I _S	Maximum Continuous Source to Drain Diode Forward Current			-	44	Α
I _{SM}	Maximum Pulsed Source to Drain Diode Forward Current			-	110	Α
V_{SD}	Source to Drain Diode Forward Voltage V _{GS} = 0 V, I _{SD} = 22 A		-	-	1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 22 A,	-	435	-	ns
Q _{rr}	Reverse Recovery Charge	$dI_F/dt = 100 A/\mu s$	-	9.2	-//	μС

Notes:

- 1. Repetitive rating: pulse width limited by maximum junction temperature.
- 2. I_{AS} = 8.8 A, R_G = 25 Ω , starting T_J = 25°C.
- 3. $I_{SD} \leq 44$ A, di/dt ≤ 200 A/µs, $V_{DD} \leq BV_{DSS},$ starting T_J = 25°C.
- ${\it 4. Essentially independent of operating temperature typical characteristic.}\\$

Typical Performance Characteristics

Figure 1. On-Region Characteristics

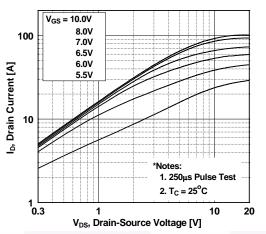


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

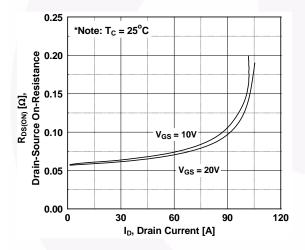


Figure 5. Capacitance Characteristics

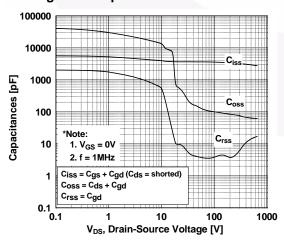


Figure 2. Transfer Characteristics

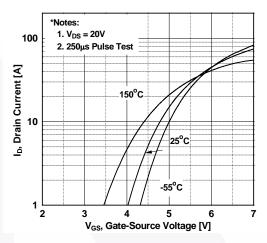


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

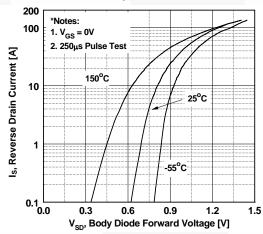
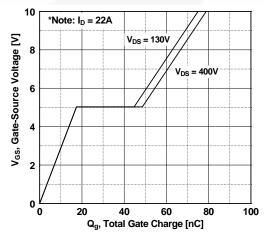


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

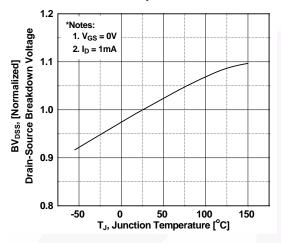


Figure 9. Maximum Safe Operating Area

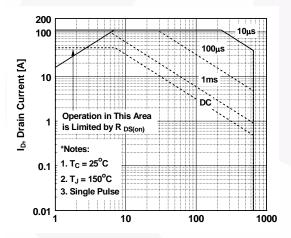


Figure 11. Eoss vs. Drain to Source Voltage

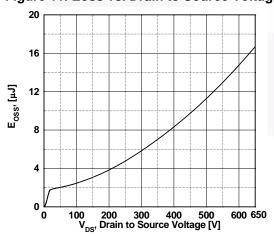


Figure 8. On-Resistance Variation vs. Temperature

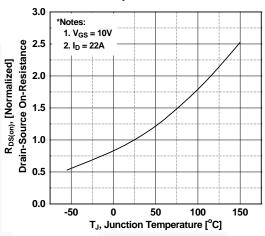
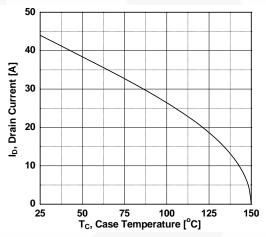
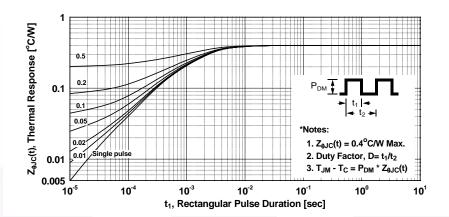


Figure 10. Maximum Drain Current vs. Case Temperature



Typical Performance Characteristics (Continued)

Figure 12. Transient Thermal Response Curve



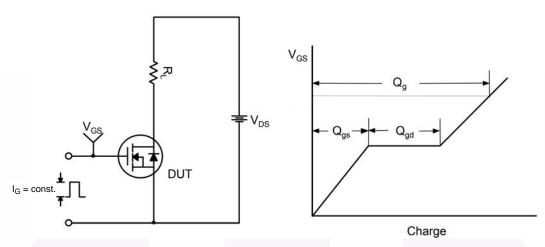


Figure 13. Gate Charge Test Circuit & Waveform

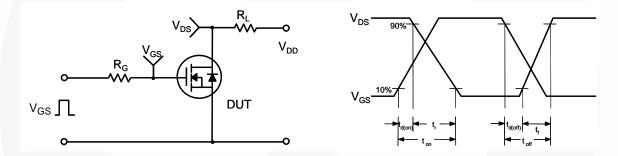


Figure 14. Resistive Switching Test Circuit & Waveforms

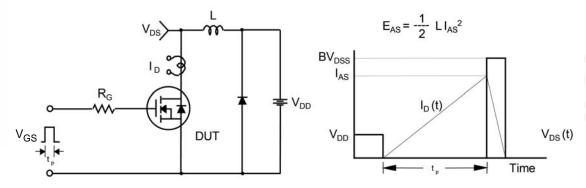


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

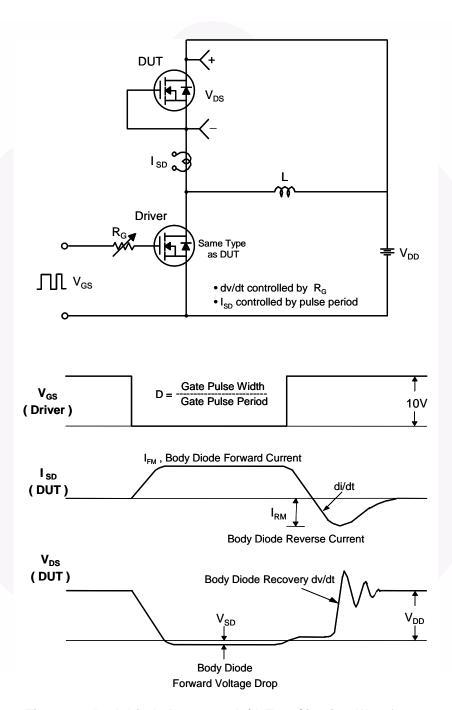
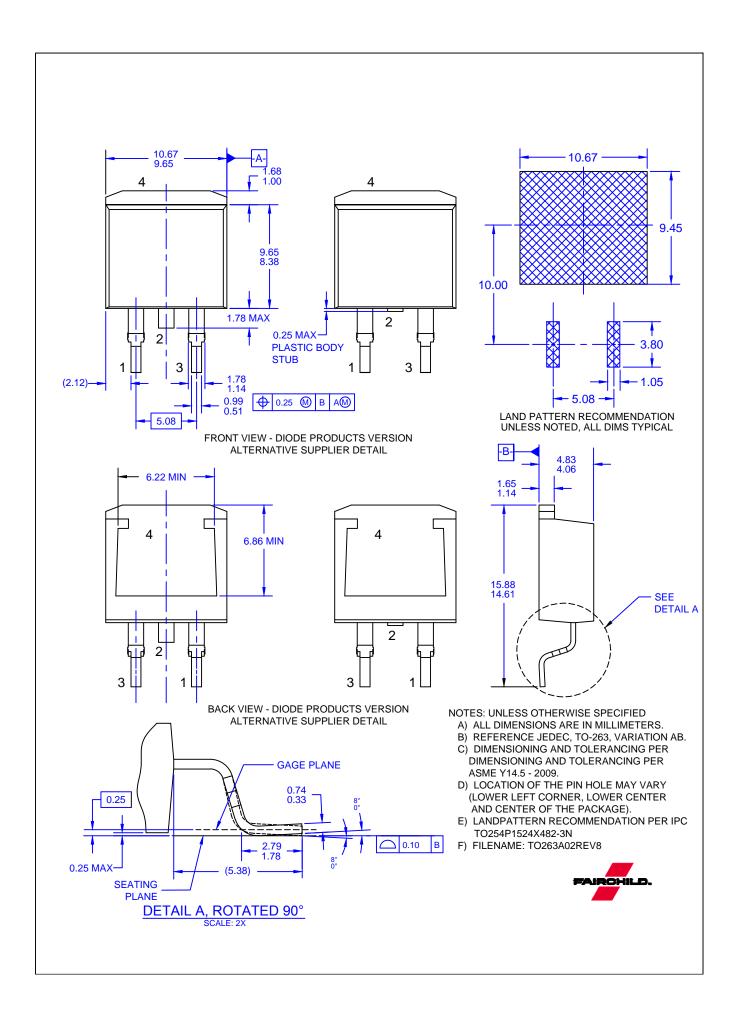


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms







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Deminition of Terms		
Datasheet Identification		Definition
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